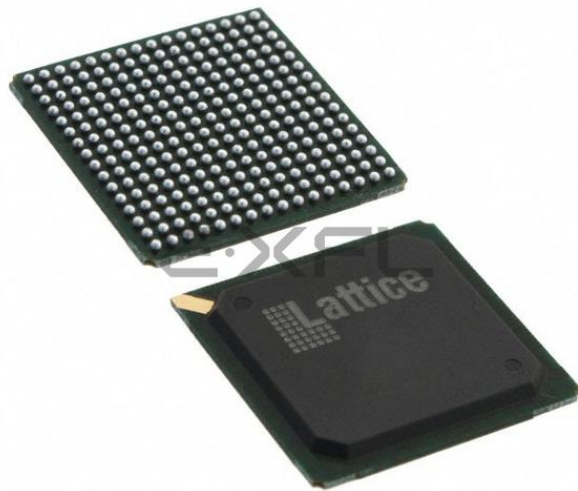




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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	140
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20se-7fn256c

SERDES and PCS (Physical Coding Sublayer)

LatticeECP2M devices feature up to 16 channels of embedded SERDES arranged in quads at the corners of the devices. Figure 2-39 shows the position of the quad blocks in relation to the PFU array for LatticeECP2M70 and LatticeECP2M100 devices. Table 2-15 shows the location of Quads for all the devices.

Each quad contains four dedicated SERDES (Ch0 to Ch3) for high-speed, full-duplex serial data transfer. Each quad also has a PCS block that interfaces to the SERDES channels and contains digital logic to support an array of popular data protocols. PCS also contains logic to the interface to FPGA core.

Figure 2-39. SERDES Quads (LatticeECP2M70/LatticeECP2M100)

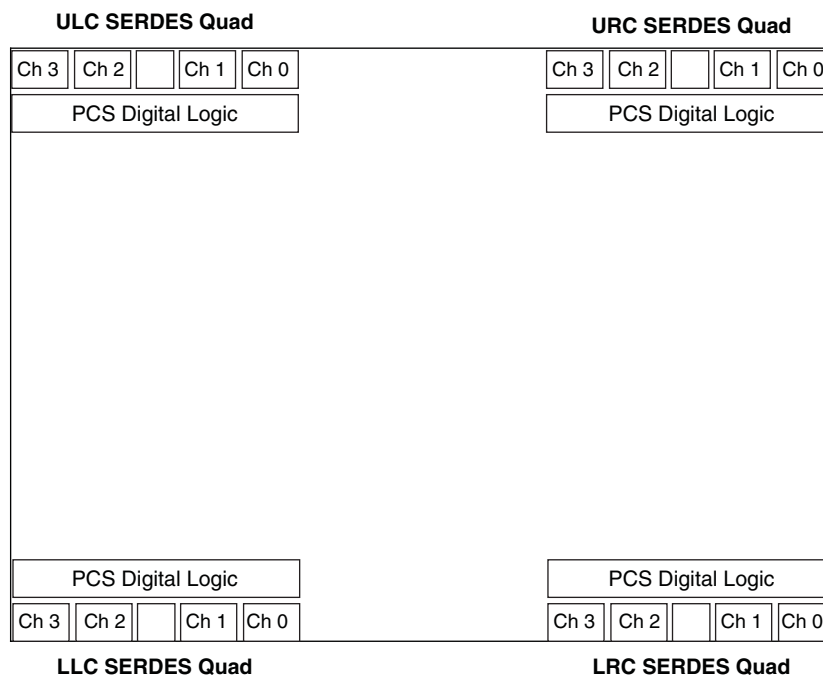


Table 2-15. Available SERDES Quads per LatticeECP2M Devices

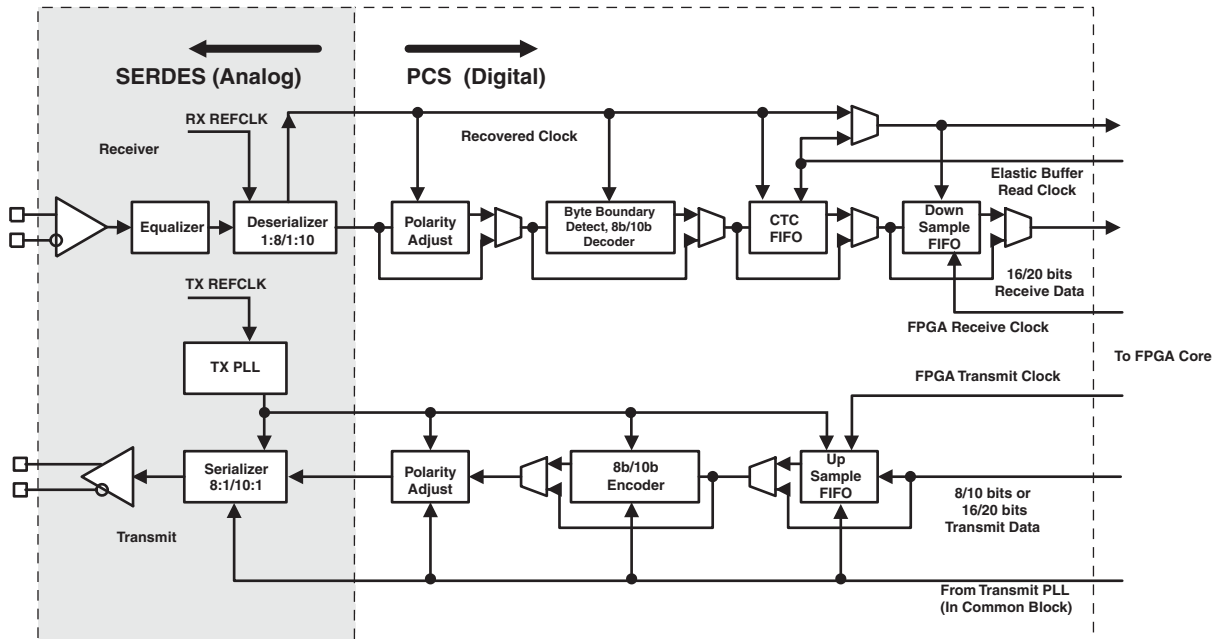
Device	URC Quad	ULC Quad	LRC Quad	LLC Quad
ECP2M20	Available	—	—	—
ECP2M35	Available	—	—	—
ECP2M50	Available	—	Available	—
ECP2M70	Available	Available	Available	Available
ECP2M100	Available	Available	Available	Available

SERDES Block

A differential receiver receives the serial encoded data stream, equalizes the signal, extracts the buried clock and de-serializes the data-stream before passing the 8- or 10-bit data to the PCS logic. The transmit channel receives the parallel (8- or 10-bit) encoded data, serializes the data and transmits the serial bit stream through the differential buffers. There is a single transmit clock per quad. Figure 2-40 shows a single channel SERDES and its interface to the PCS logic. Each SERDES receiver channel provides a recovered clock to the PCS block and to the FPGA core logic.

Each Transmit and Receive channel has its independent power supplies. The Output and Input buffers of each channel also have their own independent power supplies. In addition, there are separate power supplies for PLL, terminating resistor per quad.

Figure 2-40. Simplified Channel Block Diagram for SERDES and PCS



PCS

As shown in Figure 2-40, the PCS receives the parallel digital data from the deserializer receivers and adjusts the polarity, detects, byte boundary, decodes (8b/10b) and provides Clock Tolerance Compensation (CTC) FIFO for changing the clock domain from receiver clock to the FPGA Clock.

For the transmit channel, the PCS block receives the parallel data from the FPGA core, encodes it with 8b/10b, adjusts the polarity and passes the 8/10 bit data to the transmit SERDES channel.

The PCS also provides bypass modes that allow a direct 8-bit or 10-bit interface from the SERDES to the FPGA logic. The PCS interface to FPGA can also be programmed to run at 1/2 speed for a 16-bit or 20-bit interface to the FPGA logic.

SCI (SERDES Client Interface) Bus

The SERDES Client Interface (SCI) is a soft IP interface that allow the SERDES/PCS Quad block to be controlled by registers as opposed to the configuration memory cells. It is a simple register configuration interface.

The Diamond design tools support all modes of the PCS. Most modes are dedicated to applications associated with a specific industry standard data protocol. Other more general purpose modes allow users to define their own operation. With Diamond, the user can define the mode for each quad in a design.

Popular standards such as 10Gb Ethernet and x4 PCI-Express and 4x Serial RapidIO can be implemented using IP (provided by Lattice), a single quad (Four SERDES channels and PCS) and some additional logic from the core.

For further information about SERDES, please see the list of additional technical documentation at the end of this data sheet.

RSDS

The LatticeECP2/M devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Signaling)

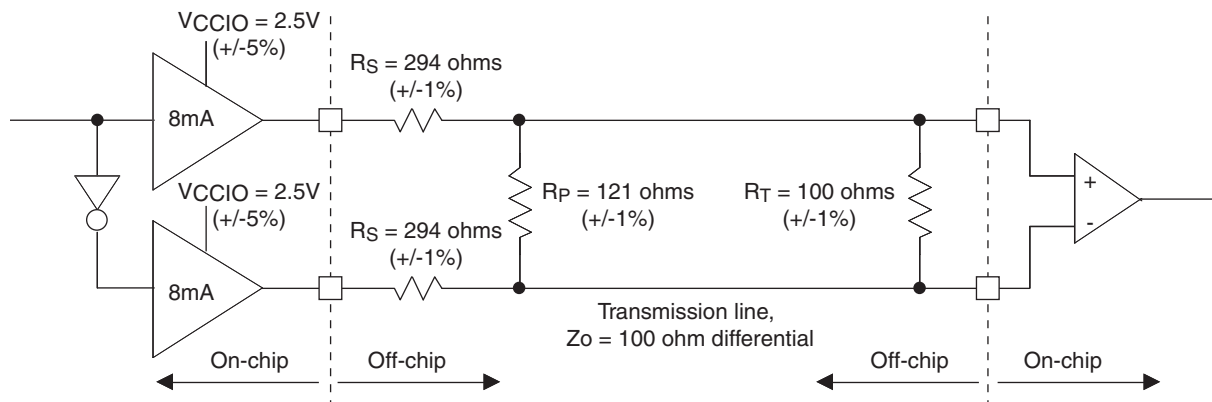


Table 3-5. RSDS DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
V _{CCIO}	Output Driver Supply (+/-5%)	2.50	V
Z _{OUT}	Driver Impedance	20	Ω
R _S	Driver Series Resistor (+/-1%)	294	Ω
R _P	Driver Parallel Resistor (+/-1%)	121	Ω
R _T	Receiver Termination (+/-1%)	100	Ω
V _{OH}	Output High Voltage	1.35	V
V _{OL}	Output Low Voltage	1.15	V
V _{OD}	Output Differential Voltage	0.20	V
V _{CM}	Output Common Mode Voltage	1.25	V
Z _{BACK}	Back Impedance	101.5	Ω
I _{DC}	DC Output Current	3.66	mA

1. For input buffer, see LVDS table.

LatticeECP2/M External Switching Characteristics⁹

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL) ¹									
t _{CO}	Clock to Output - PIO Output Register	LFE2-6	—	3.50	—	3.90	—	4.20	ns
		LFE2-12	—	3.50	—	3.90	—	4.20	ns
		LFE2-20	—	3.50	—	3.90	—	4.20	ns
		LFE2-35	—	3.50	—	3.90	—	4.20	ns
		LFE2-50	—	3.50	—	3.90	—	4.20	ns
		LFE2-70	—	3.70	—	4.10	—	4.40	ns
		LFE2M20	—	3.90	—	4.30	—	4.70	ns
		LFE2M35	—	3.90	—	4.30	—	4.70	ns
		LFE2M50	—	4.50	—	5.00	—	5.40	ns
		LFE2M70	—	4.50	—	5.00	—	5.40	ns
		LFE2M100	—	4.50	—	5.00	—	5.40	ns
t _{SU}	Clock to Data Setup - PIO Input Register	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
t _H	Clock to Data Hold - PIO Input Register	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.80	—	2.10	—	2.30	—	ns
		LFE2M70	1.80	—	2.10	—	2.30	—	ns
		LFE2M100	1.80	—	2.10	—	2.30	—	ns

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

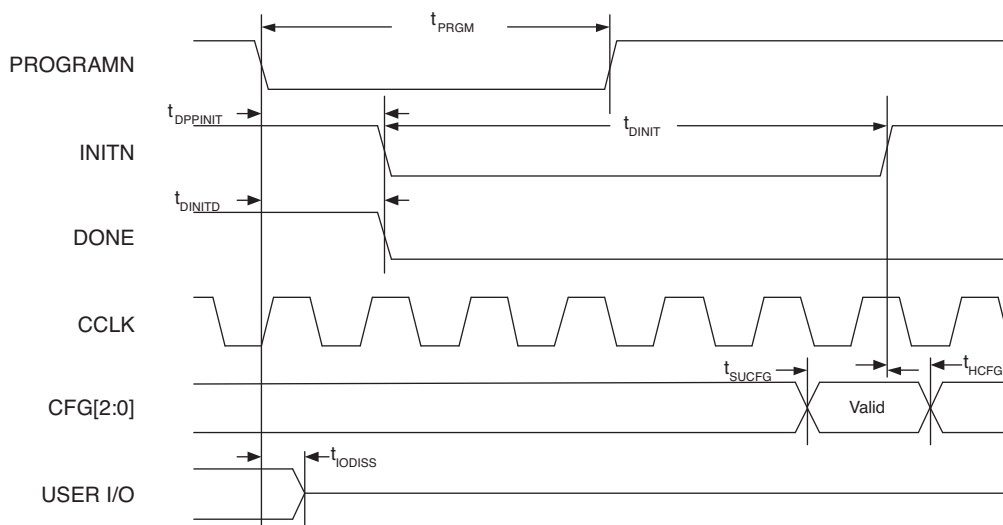
Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{H_DELE}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IOE}	Clock Frequency of I/O and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Primary Clock with PLL)¹									
t _{COPLL} ¹⁰	Clock to Output - PIO Output Register	LFE2-6	—	2.30	—	2.60	—	2.80	ns
		LFE2-12	—	2.30	—	2.60	—	2.80	ns
		LFE2-20	—	2.30	—	2.60	—	2.80	ns
		LFE2-35	—	2.30	—	2.60	—	2.80	ns
		LFE2-50	—	2.30	—	2.60	—	2.80	ns
		LFE2-70	—	2.30	—	2.60	—	2.80	ns
		LFE2M20	—	2.30	—	2.60	—	2.80	ns
		LFE2M35	—	2.30	—	2.60	—	2.80	ns
		LFE2M50	—	2.60	—	2.90	—	3.10	ns
		LFE2M70	—	2.60	—	2.90	—	3.10	ns
		LFE2M100	—	2.70	—	3.00	—	3.20	ns
t _{SUPLL}	Clock to Data Setup - PIO Input Register	LFE2-6	0.70	—	0.80	—	0.90	—	ns
		LFE2-12	0.70	—	0.80	—	0.90	—	ns
		LFE2-20	0.70	—	0.80	—	0.90	—	ns
		LFE2-35	0.70	—	0.80	—	0.90	—	ns
		LFE2-50	0.70	—	0.80	—	0.90	—	ns
		LFE2-70	0.70	—	0.80	—	0.90	—	ns
		LFE2M20	0.70	—	0.80	—	0.90	—	ns
		LFE2M35	0.70	—	0.80	—	0.90	—	ns
		LFE2M50	0.70	—	0.80	—	0.90	—	ns
		LFE2M70	0.70	—	0.80	—	0.90	—	ns
		LFE2M100	0.80	—	0.90	—	1.00	—	ns

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR2}	DDR Clock Frequency	ECP2/M	133	266	133	200	133	166	MHz
SPI4.2 I/O Pin Parameters Static Alignment^{4, 8, 11}									
	Maximum Data Rate	ECP2-20	—	750	—	622	—	622	Mbps
		ECP2-35	—	750	—	622	—	622	Mbps
		ECP2-50	—	750	—	622	—	622	Mbps
		ECP2-70	—	750	—	622	—	622	Mbps
		ECP2M20	—	622	—	622	—	622	Mbps
		ECP2M35	—	622	—	622	—	622	Mbps
		ECP2M50	—	622	—	622	—	622	Mbps
		ECP2M70	—	622	—	622	—	622	Mbps
		ECP2M100	—	622	—	622	—	622	Mbps
$t_{DVACLKSPI}$	Data Valid After CLK (Receive)	ECP2-20	—	0.25	—	0.25	—	0.25	UI
		ECP2-35	—	0.25	—	0.25	—	0.25	UI
		ECP2-50	—	0.25	—	0.25	—	0.25	UI
		ECP2-70	—	0.25	—	0.25	—	0.25	UI
		ECP2M20	—	0.21	—	0.21	—	0.21	UI
		ECP2M35	—	0.21	—	0.21	—	0.21	UI
		ECP2M50	—	0.21	—	0.21	—	0.21	UI
		ECP2M70	—	0.21	—	0.21	—	0.21	UI
		ECP2M100	—	0.21	—	0.21	—	0.21	UI
$t_{DVECLKSPI}$	Data Hold After CLK (Receive)	ECP2-20	0.75	—	0.75	—	0.75	—	UI
		ECP2-35	0.75	—	0.75	—	0.75	—	UI
		ECP2-50	0.75	—	0.75	—	0.75	—	UI
		ECP2-70	0.75	—	0.75	—	0.75	—	UI
		ECP2M20	0.79	—	0.79	—	0.79	—	UI
		ECP2M35	0.79	—	0.79	—	0.79	—	UI
		ECP2M50	0.79	—	0.79	—	0.79	—	UI
		ECP2M70	0.79	—	0.79	—	0.79	—	UI
		ECP2M100	0.79	—	0.79	—	0.79	—	UI
t_{DIASPI}	Data Invalid After Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps

Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

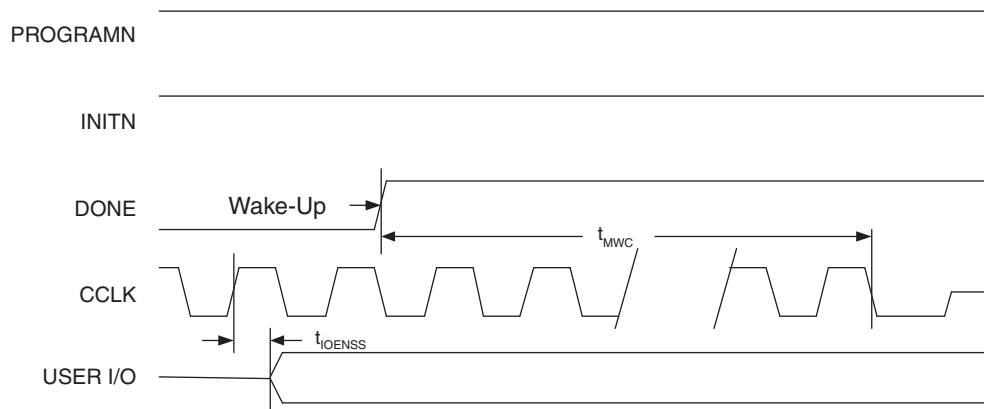
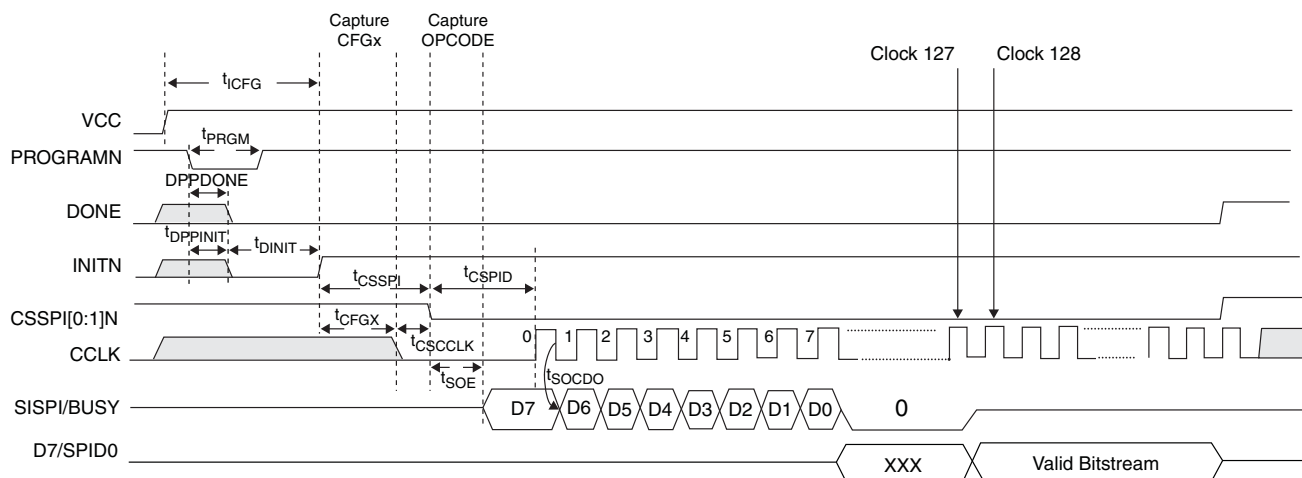


Figure 3-20. SPI/SPI_m Configuration Waveforms



PICs and DDR Data (DQ) Pins Associated with the DDR Strobe (DQS) Pin

PICs Associated with DQS Strobe	PIO Within PIC	DDR Strobe (DQS) and Data (DQ) Pins
For Left and Right Edges of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
For Bottom Edge of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
P[Edge] [n+4]	A	DQ
	B	DQ

Notes:

1. "n" is a row PIC number.
2. The DDR interface is designed for memories that support one DQS strobe up to 15 bits of data for the left and right edges and up to 17 bits of data for the bottom edge. In some packages, all the potential DDR data (DQ) pins may not be available. PIC numbering definitions are provided in the "Signal Names" column of the Signal Descriptions table.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*	
5	GND	-			GND	-			
6	PL6A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ16	T (LVDS)*	
7	VCCAUX	-			VCCAUX	-			
8	PL6B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ16	C (LVDS)*	
9	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*	
10	VCCIO7	7			VCCIO7	7			
11	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*	
12	VCC	-			VCC	-			
13	GND	-			GND	-			
14	VCCIO7	7			VCCIO7	7			
15	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*	
16	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*	
17	GND	-			GND	-			
18	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T	
19	VCC	-			VCC	-			
20	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C	
21	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	
22	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	
23	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T	
24	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C	
25	GND	-			GND	-			
26	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	
27	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	
28	VCC	-			VCC	-			
29	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
30	VCCAUX	-			VCCAUX	-			
31	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	
32	GND	-			GND	-			
33	PL21A	6	LLM0_GPLLT_FB_A	T	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	
34	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	
35	PL21B	6	LLM0_GPLLC_FB_A	C	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	
36	PL23A	6			PL33A	6	LDQ34		
37	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*	
38	VCCIO6	6			VCCIO6	6			
39	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*	
40	VCC	-			VCC	-			
41	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*	
42	GND	-			GND	-			
43	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
44	VCCIO6	6			VCCIO6	6			
45	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W19	CFG2	8			CFG2	8		
V19	CFG1	8			CFG1	8		
V20	PROGRAMN	8			PROGRAMN	8		
W20	CFG0	8			CFG0	8		
U22	PR28B	8	D1	C	PR42B	8	D1	C
V22	INITN	8			INITN	8		
R16	PR30B	8	WRITEN	C	PR44B	8	WRITEN	C
GNDIO	GNDIO8	-			GNDIO8	-		
W22	CCLK	8			CCLK	8		
R17	PR30A	8	CS1N	T	PR44A	8	CS1N	T
V21	DONE	8			DONE	8		
VCCIO	VCCIO8	8			VCCIO8	8		
U19	PR29B	8	CSN	C	PR43B	8	CSN	C
T17	PR26B	8	D5	C	PR40B	8	D5	C
U20	PR29A	8	D0/SPIFASTN	T	PR43A	8	D0/SPIFASTN	T
U21	PR28A	8	D2	T	PR42A	8	D2	T
GNDIO	GNDIO8	-			GNDIO8	-		
T18	PR26A	8	D6	T	PR40A	8	D6	T
T20	PR27B	8	D3	C	PR41B	8	D3	C
T21	PR25B	8	D7/SPID0	C	PR39B	8	D7/SPID0	C
T19	PR27A	8	D4	T	PR41A	8	D4	T
VCCIO	VCCIO8	8			VCCIO8	8		
T22	PR25A	8	DI/CSSPI0N	T	PR39A	8	DI/CSSPI0N	T
R18	PR24B	8	DOUT/CSON	C	PR38B	8	DOUT/CSON	C
R19	PR24A	8	BUSY/SISPI	T	PR38A	8	BUSY/SISPI	T
-	-	-			VCCIO3	3		
GNDIO	GNDIO3	-			GNDIO3	-		
P18	PR22B	3		C (LVDS)*	PR32B	3	RDQ34	C (LVDS)*
R22	PR23B	3		C	PR33B	3	RDQ34	C
P19	PR22A	3		T (LVDS)*	PR32A	3	RDQ34	T (LVDS)*
R21	PR23A	3		T	PR33A	3	RDQ34	T
VCCIO	VCCIO3	3			VCCIO3	3		
R20	PR21B	3	RLM0_GPLL_C_FB_A	C	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C
P22	PR21A	3	RLM0_GPLLT_FB_A	T	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T
P21	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*
N21	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*
N17	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
N22	PR18B	3	RLM0_GDLL_C_FB_A	C	PR28B	3	RLM0_GDLL_C_FB_A/RDQ25	C
M22	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR27B	3	RLM0_GDLL_C_IN_A**/RDQ25	C (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
N20	PR18A	3	RLM0_GDLLT_FB_A	T	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T
M21	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*
N19	NC	-			PR26B	3	RDQ25	C
-	-	-			VCCIO3	3		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D15	PT52A	1		T	PT61A	1		T
E15	PT51B	1		C	PT60B	1		C
F15	PT51A	1		T	PT60A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
B15	PT49B	1		C	PT58B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
A15	PT49A	1		T	PT58A	1		T
B14	PT48B	1		C	PT57B	1		C
A14	PT48A	1		T	PT57A	1		T
D14	PT46B	1		C	PT55B	1		C
C13	PT46A	1		T	PT55A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
E14	PT45B	1		C	PT54B	1		C
F14	PT45A	1		T	PT54A	1		T
A13	PT44B	1		C	PT53B	1		C
B13	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO	1		
E13	PT43B	1		C	PT52B	1		C
D13	PT43A	1		T	PT52A	1		T
E12	PT42B	1		C	PT51B	1		C
D12	PT42A	1		T	PT51A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A12	PT40B	1		C	PT49B	1		C
A11	PT40A	1		T	PT49A	1		T
VCCIO	VCCIO1	1			VCCIO	1		
B12	PT39B	1	PCLKC1_0	C	PT48B	1	PCLKC1_0	C
C12	PT39A	1	PCLKT1_0	T	PT48A	1	PCLKT1_0	T
F12	XRES	1			XRES	1		
B10	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	0		
B11	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T
A10	PT36B	0		C	PT45B	0		C
A9	PT36A	0		T	PT45A	0		T
C11	PT35B	0		C	PT44B	0		C
VCCIO	VCCIO0	0			VCCIO	0		
C10	PT35A	0		T	PT44A	0		T
E11	PT34B	0		C	PT43B	0		C
F11	PT34A	0		T	PT43A	0		T
A8	PT33B	0		C	PT42B	0		C
A7	PT33A	0		T	PT42A	0		T
B8	PT32B	0		C	PT41B	0		C
GNDIO	GNDIO0	-			GNDIO0	0		
B9	PT32A	0		T	PT41A	0		T
VCCIO	VCCIO0	0			VCCIO	0		
B7	PT30B	0		C	PT39B	0		C
A6	PT30A	0		T	PT39A	0		T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G19	GND	-			GND	-			
G4	GND	-			GND	-			
H10	GND	-			GND	-			
H13	GND	-			GND	-			
J14	GND	-			GND	-			
J9	GND	-			GND	-			
K10	GND	-			GND	-			
K11	GND	-			GND	-			
K12	GND	-			GND	-			
K13	GND	-			GND	-			
K15	GND	-			GND	-			
K20	GND	-			GND	-			
K3	GND	-			GND	-			
K8	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			
L12	GND	-			GND	-			
L13	GND	-			GND	-			
M10	GND	-			GND	-			
M11	GND	-			GND	-			
M12	GND	-			GND	-			
M13	GND	-			GND	-			
N10	GND	-			GND	-			
N11	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N15	GND	-			GND	-			
N20	GND	-			GND	-			
N3	GND	-			GND	-			
N8	GND	-			GND	-			
P14	GND	-			GND	-			
P9	GND	-			GND	-			
R10	GND	-			GND	-			
R13	GND	-			GND	-			
T19	GND	-			GND	-			
T4	GND	-			GND	-			
W16	GND	-			GND	-			
W2	GND	-			GND	-			
W21	GND	-			GND	-			
W7	GND	-			GND	-			
Y10	GND	-			GND	-			
Y13	GND	-			GND	-			
D15	NC	-			NC	-			
G14	NC	-			NC	-			
G15	NC	-			NC	-			
D14	NC	-			NC	-			
E15	NC	-			NC	-			
E14	NC	-			NC	-			

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
F20	PR30A	2	RDQ27	T
GNDIO	GNDIO2	-		
G17	PR29B	2	RDQ27	C (LVDS)*
F17	PR29A	2	RDQ27	T (LVDS)*
VCCIO	VCCIO2	2		
GNDIO	GNDIO2	-		
E22	PR14B	2		C
D22	PR14A	2		T
VCCIO	VCCIO2	-		
E20	PR13B	2		C (LVDS)*
D20	PR13A	2		T (LVDS)*
D19	PR12B	2	RUM0_SPLLC_FB_A	C
GNDIO	GNDIO2	-		
E19	PR12A	2	RUM0_SPLLT_FB_A	T
F18	PR11B	2	RUM0_SPLLC_IN_A	C (LVDS)*
F19	PR11A	2	RUM0_SPLLT_IN_A	T (LVDS)*
VCCIO	VCCIO2	-		
E18	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-		
D18	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2		
F16	XRES	-		
C22	URC_SQ_VCCR0	12		
A21	URC_SQ_HDINP0	12		T
B22	URC_SQ_VCCIB0	12		
B21	URC_SQ_HDINN0	12		C
C19	URC_SQ_VCCTX0	12		
A18	URC_SQ_HDOUTP0	12		T
A19	URC_SQ_VCCOB0	12		
B18	URC_SQ_HDOUTN0	12		C
C18	URC_SQ_VCCTX1	12		
B17	URC_SQ_HDOUTN1	12		C
C17	URC_SQ_VCCOB1	12		
A17	URC_SQ_HDOUTP1	12		T
C21	URC_SQ_VCCR1	12		
B20	URC_SQ_HDINN1	12		C
C20	URC_SQ_VCCIB1	12		
A20	URC_SQ_HDINP1	12		T
B16	URC_SQ_VCCAUX33	12		
E17	URC_SQ_REFCLKN	12		C
D17	URC_SQ_REFCLKP	12		T
C16	URC_SQ_VCCP	12		
A12	URC_SQ_HDINP2	12		T

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C12	URC_SQ_VCCIB2	12		
B12	URC_SQ_HDINN2	12		C
C11	URC_SQ_VCCR2	12		
A15	URC_SQ_HDOUTP2	12		T
C15	URC_SQ_VCCOB2	12		
B15	URC_SQ_HDOUTN2	12		C
C14	URC_SQ_VCCTX2	12		
B14	URC_SQ_HDOUTN3	12		C
A13	URC_SQ_VCCOB3	12		
A14	URC_SQ_HDOUTP3	12		T
C13	URC_SQ_VCCTX3	12		
B11	URC_SQ_HDINN3	12		C
B10	URC_SQ_VCCIB3	12		
A11	URC_SQ_HDINP3	12		T
C10	URC_SQ_VCCR3	12		
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
E13	PT55B	1		C
D12	PT55A	1		T
GNDIO	GNDIO1	-		
A9	PT54B	1		C
A8	PT54A	1		T
A7	PT53B	1		C
A6	PT53A	1		T
VCCIO	VCCIO1	1		
E12	PT52B	1		C
F12	PT52A	1		T
A5	PT51B	1		C
A4	PT51A	1		T
GNDIO	GNDIO1	-		
B7	PT50B	1		C
B8	PT50A	1		T
G11	PT49B	1		C
E11	PT49A	1		T
VCCIO	VCCIO1	1		
D11	PT48B	1	VREF2_1	C
D10	PT48A	1	VREF1_1	T
G10	PT47B	1	PCLKC1_0	C
F11	PT47A	1	PCLKT1_0	T
G9	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
F9	PT46A	0	PCLKT0_0	T
C9	PT45B	0	VREF2_0	C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
N23	PR37A	3	PCLKT3_0	T (LVDS)*	PR41A	3	PCLKT3_0	T*	
N24	PR35B	2	PCLKC2_0/RDQ32	C	PR39B	2	PCLKC2_0/RDQ36	C	
N25	PR35A	2	PCLKT2_0/RDQ32	T	PR39A	2	PCLKT2_0/RDQ36	T	
GNDIO	GNDIO2	-			GNDIO2	-			
M22	PR34B	2	RDQ32	C (LVDS)*	PR38B	2	RDQ36	C*	
M24	PR34A	2	RDQ32	T (LVDS)*	PR38A	2	RDQ36	T*	
M23	PR33B	2	RDQ32	C	PR37B	2	RDQ36	C	
N26	PR33A	2	RDQ32	T	PR37A	2	RDQ36	T	
VCCIO	VCCIO2	2			VCCIO2	2			
L22	PR32B	2	RDQ32	C (LVDS)*	PR36B	2	RDQ36	C*	
L24	PR32A	2	RDQS32	T (LVDS)*	PR36A	2	RDQS36	T*	
L23	PR31B	2	RDQ32	C	PR35B	2	RDQ36	C	
GNDIO	GNDIO2	-			GNDIO2	-			
M20	PR31A	2	RDQ32	T	PR35A	2	RDQ36	T	
M26	PR30B	2	RDQ32	C (LVDS)*	PR34B	2	RDQ36	C*	
L26	PR30A	2	RDQ32	T (LVDS)*	PR34A	2	RDQ36	T*	
K22	PR29B	2	RUM1_SPLLC_FB_A/RDQ32	C	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C	
VCCIO	VCCIO2	2			VCCIO2	2			
M19	PR29A	2	RUM1_SPLLT_FB_A/RDQ32	T	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T	
K25	PR28B	2	RUM1_SPLLC_IN_A/RDQ32	C (LVDS)*	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C*	
K26	PR28A	2	RUM1_SPLLT_IN_A/RDQ32	T (LVDS)*	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T*	
K24	PR26B	2	RDQ23	C	PR30B	2	RDQ27	C	
K23	PR26A	2	RDQ23	T	PR30A	2	RDQ27	T	
GNDIO	GNDIO2	-			GNDIO2	-			
L19	PR25B	2	RDQ23	C (LVDS)*	PR29B	2	RDQ27	C*	
K21	PR25A	2	RDQ23	T (LVDS)*	PR29A	2	RDQ27	T*	
J23	PR24B	2	RDQ23	C	PR28B	2	RDQ27	C	
J24	PR24A	2	RDQ23	T	PR28A	2	RDQ27	T	
VCCIO	VCCIO2	2			VCCIO2	2			
K20	PR23B	2	RDQ23	C (LVDS)*	PR27B	2	RDQ27	C*	
J21	PR23A	2	RDQS23	T (LVDS)*	PR27A	2	RDQS27	T*	
H21	PR22B	2	RDQ23	C	PR26B	2	RDQ27	C	
GNDIO	GNDIO2	-			GNDIO2	-			
K18	PR22A	2	RDQ23	T	PR26A	2	RDQ27	T	
H22	PR21B	2	RDQ23	C (LVDS)*	PR25B	2	RDQ27	C*	
J20	PR21A	2	RDQ23	T (LVDS)*	PR25A	2	RDQ27	T*	
J25	PR20B	2	RDQ23	C	PR24B	2	RDQ27	C	
VCCIO	VCCIO2	2			VCCIO2	2			
J26	PR20A	2	RDQ23	T	PR24A	2	RDQ27	T	
G21	PR19B	2	RDQ23	C (LVDS)*	PR23B	2	RDQ27	C*	
J19	PR19A	2	RDQ23	T (LVDS)*	PR23A	2	RDQ27	T*	
GNDIO	GNDIO2	-			GNDIO2	-			
H23	PR18B	2	RDQ15	C	PR21B	2		C	
H24	PR18A	2	RDQ15	T	PR21A	2		T	
H25	PR17B	2	RDQ15	C (LVDS)*	PR20B	2		C*	
H26	PR17A	2	RDQ15	T (LVDS)*	PR20A	2		T*	
VCCIO	VCCIO2	2			VCCIO2	2			
G22	PR16B	2	RDQ15	C	PR19B	2		C	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D19	PT93B	1		C
E18	PT93A	1		T
D18	PT92B	1		C
C17	PT92A	1		T
A17	PT91B	1		C
B17	PT91A	1		T
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
J18	PT75B	1		C
J19	PT75A	1		T
H17	PT74B	1		C
J17	PT74A	1		T
F18	PT73B	1		C
F17	PT73A	1		T
GNDIO	GNDIO1	-		
A16	PT72B	1		C
B16	PT72A	1		T
G17	PT71B	1		C
G16	PT71A	1		T
VCCIO	VCCIO1	1		
H16	PT70B	1		C
F16	PT70A	1		T
J16	PT69B	1		C
G15	PT69A	1		T
GNDIO	GNDIO1	-		
C16	PT68B	1		C
D16	PT68A	1		T
J15	PT67B	1		C
H15	PT67A	1		T
VCCIO	VCCIO1	1		
A15	PT66B	1	VREF2_1	C
B15	PT66A	1	VREF1_1	T
F15	PT65B	1	PCLKC1_0	C
E16	PT65A	1	PCLKT1_0	T
C15	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
D15	PT64A	0	PCLKT0_0	T
C14	PT63B	0	VREF2_0	C
E15	PT63A	0	VREF1_0	T
G14	PT62B	0		C
VCCIO	VCCIO0	0		
J14	PT62A	0		T
F14	PT61B	0		C

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	COM	100
LFE2M100E-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	COM	100
LFE2M100E-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	COM	100
LFE2M100E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	100
LFE2M100E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	100
LFE2M100E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	100

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484I	304	1.2V	-5	Lead-Free fpBGA	484	IND	20
LFE2M20E-6FN484I	304	1.2V	-6	Lead-Free fpBGA	484	IND	20
LFE2M20E-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	IND	20
LFE2M20E-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672I	410	1.2V	-5	Lead-Free fpBGA	672	IND	35
LFE2M35E-6FN672I	410	1.2V	-6	Lead-Free fpBGA	672	IND	35
LFE2M35E-5FN484I	303	1.2V	-5	Lead-Free fpBGA	484	IND	35
LFE2M35E-6FN484I	303	1.2V	-6	Lead-Free fpBGA	484	IND	35
LFE2M35E-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	IND	35
LFE2M35E-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900I	410	1.2V	-5	Lead-Free fpBGA	900	Ind	50
LFE2M50E-6FN900I	410	1.2V	-6	Lead-Free fpBGA	900	Ind	50
LFE2M50E-5FN672I	372	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2M50E-6FN672I	372	1.2V	-6	Lead-Free fpBGA	672	Ind	50
LFE2M50E-5FN484I	270	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2M50E-6FN484I	270	1.2V	-6	Lead-Free fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152I	436	1.2V	-5	Lead-Free fpBGA	1152	Ind	70
LFE2M70E-6FN1152I	436	1.2V	-6	Lead-Free fpBGA	1152	Ind	70
LFE2M70E-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2M70E-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	70

LatticeECP2M S-Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2M20SE-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2M20SE-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2M20SE-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2M20SE-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2M20SE-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	Com	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	Com	35
LFE2M35SE-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	Com	35
LFE2M35SE-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	Com	35
LFE2M35SE-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	Com	35
LFE2M35SE-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	Com	35
LFE2M35SE-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	Com	35
LFE2M35SE-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	Com	35
LFE2M35SE-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	Com	35
LFE2M35SE-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	Com	50
LFE2M50SE-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	Com	50
LFE2M50SE-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	Com	50
LFE2M50SE-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	Com	50
LFE2M50SE-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	Com	50
LFE2M50SE-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	Com	50
LFE2M50SE-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	Com	50
LFE2M50SE-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	Com	50
LFE2M50SE-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	Com	70
LFE2M70SE-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	Com	70
LFE2M70SE-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	Com	70
LFE2M70SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	70
LFE2M70SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	70
LFE2M70SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	70

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
April 2008	03.1	Pinout Information	Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
June 2008	03.2	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
		Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
August 2008	03.3	DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.